## INTEGRATED CIRCUITS

# DATA SHEET

**74F153**Dual 4-line to 1-line multiplexer

Product specification

1996 Jan 05

IC15 Data Handbook





74F153

#### **FEATURES**

- Non-inverting outputs
- Separate enable for each section
- Common select inputs
- See 74F253 for 3-State version

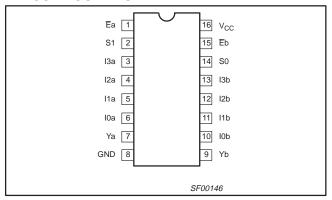
#### **DESCRIPTION**

The 74F153 is a dual 4-input multiplexer that can select 2 bits of data from up to four sources selected by common Select inputs (S0, S1). The two 4-input multiplexer circuits have individual active-Low Enables (Ea, Eb) which can be used to strobe the outputs independently. Outputs (Ya, Yb) are forced Low when the corresponding Enables (Ea, Eb) are High.

The 74F153 is the logic implementation of a 2-pole, 4-position switch where the switch is determined by the logic levels supplied to the common select inputs.

	TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
ſ	74F153	7.0ns	12mA

#### **PIN CONFIGURATION**



#### ORDERING INFORMATION

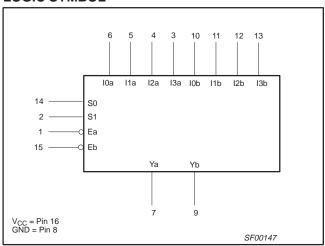
DESCRIPTION	COMMERCIAL RANGE $V_{CC}$ = 5V $\pm 10\%$ , $T_{amb}$ = 0°C to +70°C	PKG. DWG.#
16-pin plastic DIP	N74F153N	SOT38-4
16-pin plastic SO	N74F153D	SOT109-1

#### INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

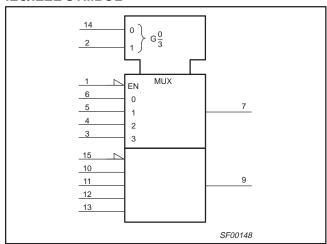
PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW		
10a – 13a	Port A data inputs	1.0/1.0	20μA/0.6mA		
10b - 13b	I0b – I3b Port B data inputs		20μA/0.6mA		
S0, S1	Common Select inputs	1.0/1.0	20μA/0.6mA		
Ea	Port A Enable input (active Low)	1.0/1.0	20μA/0.6mA		
Eb	Port B Enable input (active Low)	1.0/1.0	20μA/0.6mA		
Ya, Yb	Port A, B data outputs	50/33	1.0μA/20mA		

**NOTE:** One (1.0) FAST unit load is defined as: 20μA in the High state and 0.6mA in the Low state.

#### LOGIC SYMBOL

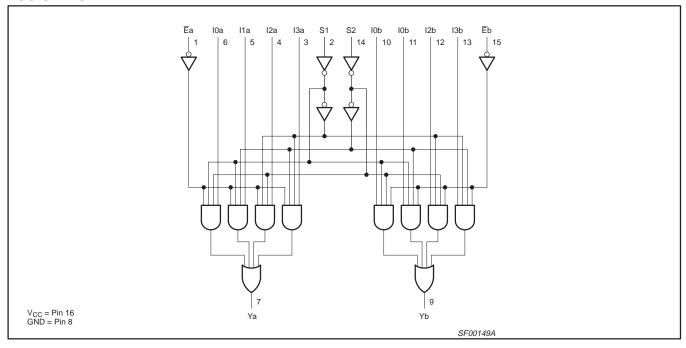


#### **IEC/IEEE SYMBOL**



74F153

### **LOGIC DIAGRAM**



### **FUNCTION TABLE**

	INPUTS										
S0	S1	En	l0n	l1n	l2n	l3n	Yn				
Х	Х	Н	Х	Х	Х	Х	L				
L	L	L	L	X	X	X	L				
L	L	L	Н	X	×	X	н				
н	L	L	X	L	×	X	L				
н	L	L	X	Н	×	X	н				
L	Н	L	Х	X	L	X	L				
L	Н	L	Х	X	Н	X	н				
Н	Н	L	Х	X	X	L	L				
Н	Н	L	Х	X	X	Н	Н				

H = High voltage level L = Low voltage level X = Don't care

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#### ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V <sub>CC</sub>	Supply voltage	-0.5 to +7.0	V
V <sub>IN</sub>	Input voltage	−0.5 to +7.0	V
I <sub>IN</sub>	Input current	−30 to +5	mA
V <sub>OUT</sub>	Voltage applied to output in High output state	−0.5 to V <sub>CC</sub>	V
I <sub>OUT</sub>	Current applied to output in Low output state	40	mA
T <sub>amb</sub>	Operating free-air temperature range	0 to +70	°C
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C

#### RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER			UNIT	
STMBOL	PARAMETER	MIN	NOM	MAX	UNII
V <sub>CC</sub>	Supply voltage	4.5	5.0	5.5	V
V <sub>IH</sub>	High-level input voltage	2.0			V
V <sub>IL</sub>	Low-level input voltage			0.8	V
I <sub>IK</sub>	Input clamp current			-18	mA
I <sub>OH</sub>	High-level output current			-1	mA
I <sub>OL</sub>	Low-level output current			20	mA
T <sub>amb</sub>	Operating free-air temperature range	0		+70	°C

#### DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

CVMDOL	DADAMETER		TEST COND	ITIONS1		UNIT			
SYMBOL	PARAMETER		TEST COND	IIION2	MIN	TYP <sup>2</sup>	MAX		
V	I limb lavel autout valtage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V <sub>CC</sub>	2.5				
V <sub>OH</sub>	High-level output voltage		V <sub>IH</sub> = MIN, I <sub>OH</sub> = MAX	±5%V <sub>CC</sub>	2.7	3.4		V	
V	Low lovel output voltage		$V_{CC} = MIN, V_{IL} = MAX$	±10%V <sub>CC</sub>		0.30	0.50	V	
V <sub>OL</sub>	Low-level output voltage		V <sub>IH</sub> = MIN, I <sub>OL</sub> = MAX	±5%V <sub>CC</sub>		0.30	0.50	v	
V <sub>IK</sub>	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.2	V	
I <sub>I</sub>	Input current at maximum inpu	t voltage	$V_{CC} = MAX, V_I = 7.0V$				100	μΑ	
I <sub>IH</sub>	High-level input current		$V_{CC} = MAX, V_I = 2.7V$				20	μΑ	
I <sub>IL</sub>	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$			-0.6	mA		
Ios	Short-circuit output current <sup>3</sup>		V <sub>CC</sub> = MAX	-60		-150	mA		
I <sub>CC</sub>	Supply current (total)	I <sub>CCH</sub>	V <sub>CC</sub> = MAX	En = GND, Sn=In=4.5V		12	20	mA	
		I <sub>CCL</sub>		En=Sn=In=GND		12	20	mA	

### NOTES:

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<sup>1.</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

All typical values are at V<sub>CC</sub> = 5V, T<sub>amb</sub> = 25°C.
Not more than one output should be shorted at a time. For testing I<sub>OS</sub>, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

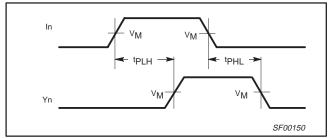
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#### **AC ELECTRICAL CHARACTERISTICS**

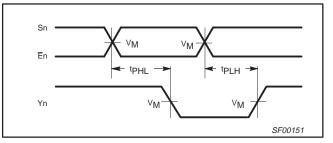
SYMBOL	PARAMETER	TEST CONDITION	T <sub>ai</sub>	<sub>CC</sub> = +5.0 <sub>mb</sub> = +25 0pF, R <sub>L</sub> =	°C	V <sub>CC</sub> = +5. T <sub>amb</sub> = 0°C C <sub>L</sub> = 50pF,	UNIT	
			MIN	TYP	MAX	MIN	MAX	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay In to Yn	Waveform 1	3.0 3.0	4.5 5.0	7.0 7.5	2.5 2.5	8.0 8.0	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay Sn to Yn	Waveform 2	5.0 5.0	8.0 8.0	10.5 10.5	4.5 4.5	12.0 12.0	ns
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay En to Yn	Waveform 2	5.0 4.0	7.5 5.5	9.0 7.0	4.5 3.5	10.5 8.0	ns

#### **AC WAVEFORMS**

For all waveforms,  $V_M = 1.5V$ .

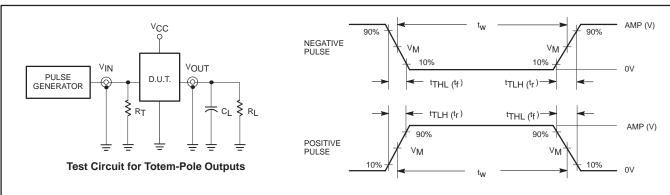


Waveform 1. Propagation Delay, Data to Output



Waveform 2. Propagation Delay, Enable and Select to Output

#### **TEST CIRCUIT AND WAVEFORMS**



#### **DEFINITIONS:**

R<sub>L</sub> = Load resistor;

see AC ELECTRICAL CHARACTERISTICS for value.

C<sub>L</sub> = Load capacitance includes jig and probe capacitance; see AC ELECTRICAL CHARACTERISTICS for value.

Termination resistance should be equal to Z<sub>OUT</sub> of pulse generators.

Input	Pulse	Definition	

INPUT PULSE REQUIREMENTS								
lailing	lallilly	amplitude	$V_{\text{M}}$	rep. rate	t <sub>w</sub>	t <sub>TLH</sub>	t <sub>THL</sub>	
	74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns	

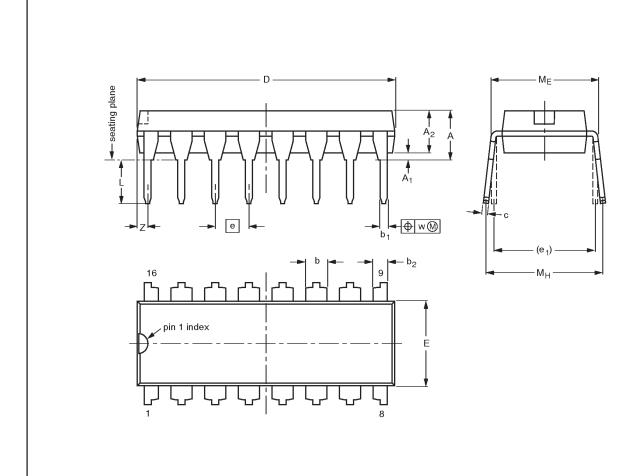
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# DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	b <sub>2</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

10 mm

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

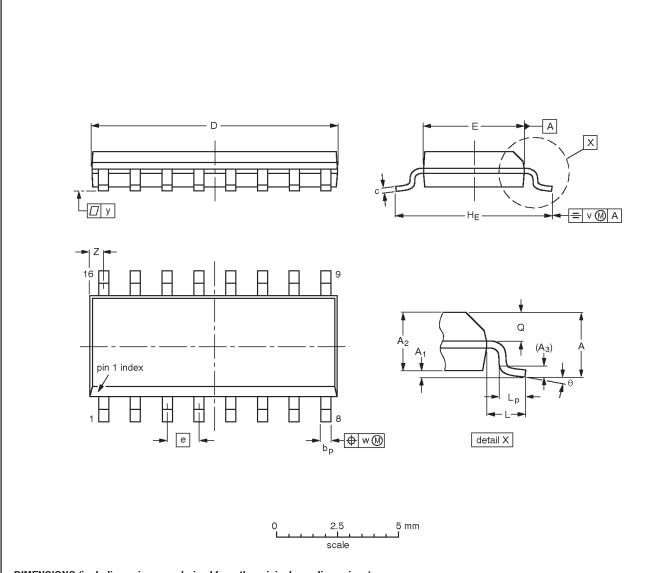
OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT38-4					<del>92-11-17</del> 95-01-14

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### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

#### Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT109-1	076E07S	MS-012AC			<del>-95-01-23</del> 97-05-22	

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#### Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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